

bq24704/5EVM (HPA297) For Multicell Synchronous Notebook Charger

The purpose of the bq24704/5EVM is for evaluating a multicell, synchronous notebook charge and path selection solution using bq24704/5 devices. This document includes a test summary, EVM schematic diagram, bill of materials, and printed-circuit board layouts.

Contents

1	Introduction	1
2	Test Summary	4
3	PCB Layout Guideline	8
4	Bill of Materials, Board Layout, and Schematics	8

List of Figures

1	Original Test Setup for HPA297 (bq24704/5EVM)	6
2	Test Setup for HPA297 (bq24704/5EVM)	7
3	Top Layer	10
4	Second Layer	11
5	Third Layer	12
6	Bottom Layer	13
7	Bottom Assembly	14
8	Top Assembly	15
9	Top Silkscreen	16

1 Introduction

1.1 EVM Features

- Evaluation module for bq24704/5
- High-efficiency NMOS-NMOS synchronous buck charger with 600-kHz (bq24705) and 300-kHz (bq24704) frequency
- Battery/adaptor to system power selector function
- User-selectable 2-cell, 3-cell, or 4-cell Li-ion battery voltage
- User-programmable battery regulation voltage with external voltage source (4.2/cell by default)
- User-programmable charge current with external voltage source (3 A by default)
- User-programmable input current limit with external voltage source (4.5 A by default)
- Pin-programmable interface for control and status communications with host
- AC adapter operating range 18 V to 22 V
- LED indication for control and status signals
- Test points for key signals available for testing purpose. Easy probe hook-up
- Jumpers available. Easy to change connections

1.2 General Description

The bq24704/5 evaluation module is a complete charger module for evaluating a multicell synchronous notebook charge and path selection solution using the bq24704/5 devices. It is designed to deliver up to 4 A of charge current to Li-ion or Li-polymer applications. The charge current is programmable by external voltage input.

The bq24704/5 has a highly integrated battery charge controller designed to work with external host commands. The battery voltage, charge current, input current limit, and other system parameters are pin programmable.

The dynamic power management (DPM) function modifies the charge current depending on system load conditions, avoiding ac adapter overload.

High-accuracy current sense amplifiers enable accurate measurement of the ac adapter current, allowing monitoring of overall system power.

For details, see bq24704 data sheet ([SLUS838](#)) and bq24705 data sheet ([SLUS779](#)) .

1.3 I/O Description

Jack		Description
J1–ACPWR		AC adapter, positive output
J1–PGND		AC adapter, negative output
J2–1	} BYPASS } BYPASS_EX	BYPASS drive signal on EVM
J2–2		Gate of Q2
J2–3		External BYPASS drive signal
J3–1	} ACDRV } ACDRV_EX	ACDRV drive signal on EVM
J3–2		Gate of Q1
J3–3		External ACDRV drive signal
J4–BYPASS_EX		External BYPASS drive signal
J4–ACDRV_EX		External ACDRV drive signal
J4–GND		Ground
J5–1	} BATDRV_EX } BATDRV	External ACDRV drive signal
J5–2		Gate of Q3
J5–3		ACDRV drive signal on EVM
J6–VPULLUP		Pullup Voltage Source
J6–CHGEN		CHGEN pin output
J7–PULLUP		Pullup voltage source
J7–LEDPWR		LED pullup power line
J8–ACGOOD		ACGOOD pin
J8–GND		Ground
J8–BAT		Connected to battery pack
J8–SYS		Connected to system
J9–1	} 4.2V REG	REGN pin
J9–2		VADJ pin
J10–VEXT		External power supply, positive output
J10–GND		External power supply, negative output
J11–CHGEN		CHGEN pin
J11–VREF		VREF pin
J11–CELLS		CELLS pin
J12–VADJ		VADJ pin
J12–ACSET		ACSET pin
J12–SRSET		SRSET pin

Jack	Description
J13–VPULLUP	Pullup voltage source
J13–CELLS	CELLS pin output
J13–GND	Ground
J14–IADPTF	R25 terminal connected to C18
J14–VREF	IC reference voltage VREF
J14– $\overline{\text{DPMDDET}}$	$\overline{\text{DPMDDET}}$ pin
J15–BYPASS	BYPASS pin
J15–LED	LED drive
J16–EXT BATDRV	External BATDRV drive signal
J16–GND	Ground
J17–ACDRV	ACDRV pin
J17–LED	LED drive
J18–BATDRV	BATDRV pin
J18–LED	LED drive

1.4 Control and Key Parameters Setting

Jack	Description	Factory Setting
J2	BYPASS drive setting 1-2: Use onboard BYPASS drive 2-3: Use external BYPASS drive	Jumper on 1-2
J3	ACDRV drive setting 1-2: Use onboard ACDRV drive 2-3: Use external ACDRV drive	Jumper on 1-2
J5	BATDRV drive setting 1-2: Use External BATDRV drive 2-3: Use onboard BATDRV drive	Jumper on 2-3
J6	Disable charge process when on	Jumper On
J7	The pullup power source supplies the LEDs when on. LED has no power source when off.	Jumper On
J9	Connect REGN to VADJ when on	Jumper On
J13	Number of cells selection 1-2 (PULLUP-CELLS) : 4 cells 2-3 (GND-LO) : 3 cells Open: 2 cells	Jumper on 2-3 (3 cells)
J15	The conduction of the BYPASS MOSFET is indicated by LED when on.	Jumper On
J17	The conduction of the AC MOSFET is indicated by LED when on.	Jumper On
J18	The conduction of the battery MOSFET is indicated by LED when on.	Jumper On

1.5 Recommended Operating Conditions

SYMBOL	DESCRIPTION	MIN	TYP	MAX	UNIT	Notes
V_{IN}	Supply voltage	18	19	22	V	
V_{BAT}	Battery voltage	6	7–16.8	20	V	
I_{AC}	Supply current	0		4.5	A	
I_{chrg}	Charge current	2	3	4	A	
T_J	Operating junction temperature range	0		125	°C	

2 Test Summary

2.1 Definitions

This procedure details how to configure the HPA297 evaluation board. On the test procedure the following naming conventions are followed. See the HPA297 schematic for details.

VXXX :	External voltage supply name (VADP, VBT, VSBT)
LOADW:	External load name (LOADR, LOADI)
V(TPyyy):	Voltage at HPA297 internal test point TPyyy. For example, V(TP12) means the voltage at TP12.
V(Jxx):	Voltage at HPA297 jack terminal Jxx.
V(TP(XXX)):	Voltage at test point XXX. For example, V(ACDET) means the voltage at the test point which is marked as <i>ACDET</i> .
V(XXX, YYY):	Voltage across point XXX and YYY.
I(JXX(YYY)):	Current going out from the YYY terminal of jack XX.
Jxx(BBB):	Terminal or pin BBB of jack xx
Jxx ON :	HPA297 internal jumper Jxx terminals are shorted
Jxx OFF:	HPA297 internal jumper Jxx terminals are open
Jxx (-YY-) ON:	HPA297 internal jumper Jxx adjacent terminals marked as YY are shorted
<i>Measure</i> : → A,B	Check specified parameters A, B. If measured values are not within specified limits the unit under test has failed.
<i>Observe</i> → A,B	A,B Observe if A, B occur. If they do not occur, the unit under test has failed.

Assembly drawings have location for jumpers, test points, and individual components.

2.2 Equipment

2.2.1 Power Supplies

Power supply #1 (PS#1): a power supply capable of supplying 20 V at 5 A is required.

Power supply #2 (PS#2): a power supply capable of supplying 5 V at 1 A is required.

Power supply #3 (PS#3): a power supply capable of supplying 20 V at 1 A is required.

2.2.2 Load #1

A 30-V (or above), 5-A (or above) electronic load that can operate at constant current mode

2.2.3 Load #2

A HP 6060B 3- to 60-V/0-to 60-A, 300-W system DC electronic load or equivalent

2.2.4 Meters

Seven Fluke 75 multimeters, (equivalent or better)

or four equivalent voltage meters and three equivalent current meters.

The current meters must be capable of measuring a 5-A+ current.

2.3 Equipment Setup

A. Set the power supply #1 for 0 V \pm 100 mVDC, 5 V \pm 0.1-A current limit and then turn off supply.

B. Connect the output of power supply #1 in series with a current meter (multimeter) to J1 (ACPWR, GND).

C. Connect a voltage meter across J1 (ACPWR, GND).

D. Set the power supply #2 for 3.3 V \pm 100 mVDC, 1 \pm 0.1-A current limit and then disable the output.

E. Set the power supply #3 for 10.5 V \pm 100 mVDC, 1 \pm 0.1-A current limit and then disable the output.

F. Connect the output of power supply #2 to J10 (VEXT, GND).

G. Turn off Load #1.

H. Turn off Load #2.

I. Connect a voltage meter across J8 (BAT, GND).

J. Connect a voltage meter across J8 (SYS, GND).

K. J2 (BYPASS): ON, J3 (ACDRV): ON, J5 (BATDRV): ON, J6: ON, J7: ON, J9: ON, J13 (CELLS, GND): ON, J15: ON, J17: ON, J18: ON.

After the preceding steps, the test setup for HPA297 (bq24704/5EVM) is shown in [Figure 1](#).

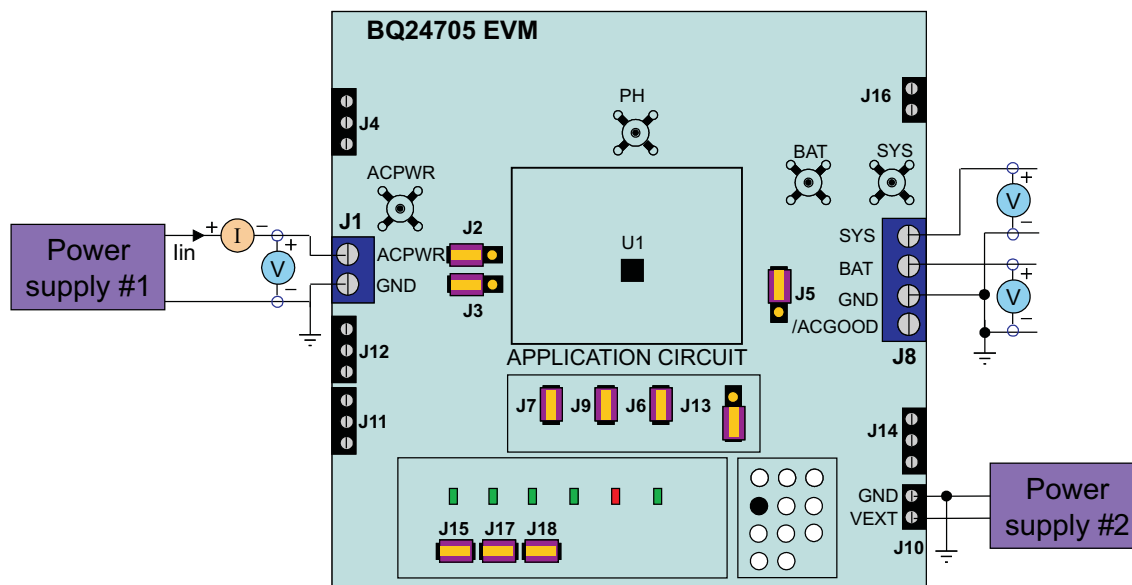


Figure 1. Original Test Setup for HPA297 (bq24704/5EVM)

2.4 Procedure

2.4.1 AC Adapter Detection Threshold

1. Make sure the Equipment Setup steps of the previous section are followed.
2. Enable the output of PS#2.
3. Turn on PS#1.
Measure → V(J8(VSYS)) = 0 ±500 mV
Measure → V(TP(VREF)) = 0 ±1 V
Measure → V(TP(REGN)) = 0 V ±500 mV
4. Increase the output voltage of PS#1 until D7 ($\overline{\text{ACGOOD}}$) is on, but do not exceed 20 V.
Measure → V(TP(ACDET)) = 2.4 V ±200 mV
Measure → V(J1(ACPWR)) = 17.9 V ±1 V
Measure → V(J8(SYS)) = 17.9 V ±1 V
Measure → V(TP(VREF)) = 3.3 V ±200 mV
Measure → V(TP(REGN)) = 0 V ±1 V
Measure → D2 (BYPASS) on. D3 (ACDRV) on.

2.4.2 Selection of Regulation Voltage

1. Increase the voltage of PS#1 until V(J1(ACPWR)) = 19 V ±0.1 V.
Measure → V(J8(BAT, GND)) = 0 V ±2 V
 Uninstall J6 (enable the charging)
Observe → D5 (CHG EN) on
Measure → V(J8(BAT)) = 12.6 V ±200 mV
Measure → V(TP(REGN)) = 6 V ±500 mV
2. Install J13 (CELLS, VPULUP)
Measure → V(J8(BAT)) = 16.8 V ±200 mV
3. Install J13(CELLS, GND)
Measure → V(J8(BAT)) = 12.6 V ±200 mV

2.4.3 Charge Current and AC Current Regulation (DPM)

1. Install J6. (Disable the charging.)
2. Connect the Load #2 in series with a current meter (multimeter) to J8 (BAT, GND). Ensure that a voltage meter is connected across J8 (BAT, GND). Turn on the Load #2. Use the constant voltage mode. Set the output voltage to 10.5 V.
3. Connect the output of the Load #1 in series with a current meter (multimeter) to J8 (SYS, GND). Ensure that a voltage meter is connected across J8 (SYS, GND). Turn on the power of the Load #1. Set the load current to 4 A \pm 50 mA but disable the output. The setup is now like Figure 2 for HPA297. Ensure that $I_{bat} = 0 \text{ A} \pm 10 \text{ mA}$ and $I_{sys} = 0 \text{ A} \pm 10 \text{ mA}$.

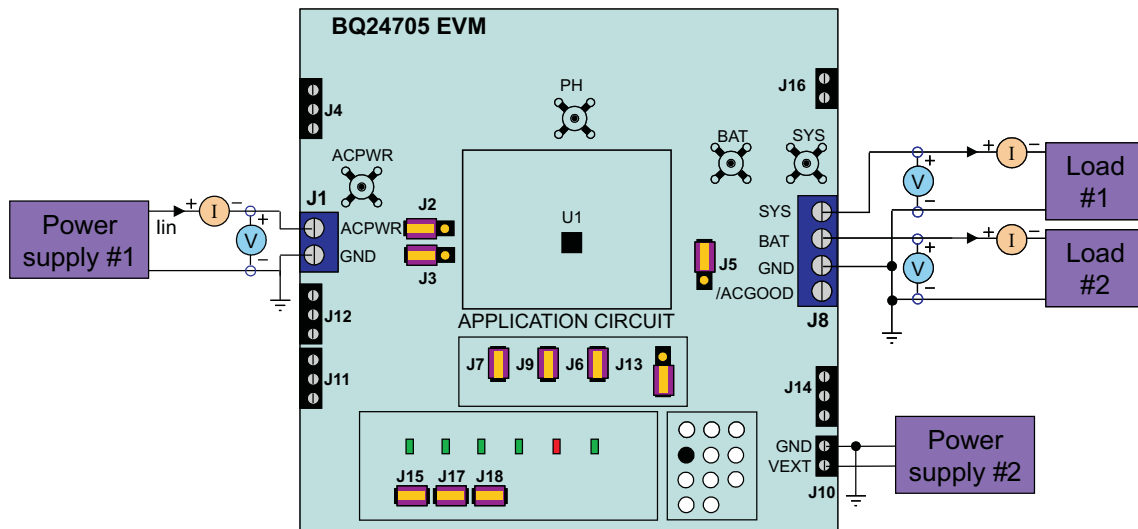


Figure 2. Test Setup for HPA297 (bq24704/5EVM)

4. Uninstall J6. (Enable the charging.)
Observe \rightarrow D5 (CHG EN) on
5. Measure $\rightarrow I_{bat} = 3000 \text{ mA} \pm 200 \text{ mA}$
Measure $\rightarrow V(TP(IADAPT)) = 350 \text{ mV} \pm 100 \text{ mV}$
6. Enable the output of the Load #1.
Observe \rightarrow D6 (DPMDET) on
Measure $\rightarrow I_{sys} = 4000 \text{ mA} \pm 200 \text{ mA}$, $I_{bat} = 800 \text{ mA} \pm 500 \text{ mA}$, $I_{lin} = 4500 \text{ mA} \pm 400 \text{ mA}$
7. Turn off the Load #1.
Measure $\rightarrow I_{sys} = 0 \pm 100 \text{ mA}$, $I_{bat} = 3000 \text{ mA} \pm 200 \text{ mA}$

2.4.4 Power Path Selection

1. Install J6. (Disable the charging.)
Observe \rightarrow D5 (CHG EN) off.
2. Replace Load #2 and current meter with PS#3. Ensure that a voltage meter is connected across J8 (BAT, GND). Enable the output of the PS #3. Ensure that the output voltage is 10.5 V \pm 500 mV.
3. *Measure* $\rightarrow V(J8(SYS)) = 19 \text{ V} \pm 1 \text{ V}$ (adapter connected to system)
Observe \rightarrow D2(BYPASS) on, D3 (ACDRV) on, D4 (BATDRV) off
4. Turn off PS#1.
Measure $\rightarrow V(J8(SYS)) = 10.5 \text{ V} \pm 1 \text{ V}$ (battery connected to system)
5. *Observe* \rightarrow D2(BYPASS) off, D3 (ACDRV) off, D4 (BATDRV) on.

3 PCB Layout Guideline

1. It is critical that the exposed power pad on the backside of the bq24704/5 package be soldered to the PCB ground. Ensure that sufficient thermal vias are right underneath the IC, connecting to the ground plane on the other layers.
2. Route the control stage and the power stage separately. At each layer, the signal ground and the power ground are connected only at the power pad.
3. AC current sense resistor must be connected to ACP and ACN with a Kelvin contact. Minimize the area of this loop. Place the decoupling capacitors for these pins as close to the IC as possible.
4. Connect the charge current sense resistor to SRP, SRN with a Kelvin contact. Minimize the area of this loop. Place the decoupling capacitors for these pins as close to the IC as possible.
5. Place the decoupling capacitors for PVCC, VREF, REGN underneath the IC (on the bottom layer), and make the interconnections to the IC as short as possible.
6. Place the decoupling capacitors for BAT, IADAPT close to the corresponding IC pins, and make the interconnections to the IC as short as possible.
7. Decoupling capacitor(s) for the charger input must be placed close to Q4 drain and Q5 source.

4 Bill of Materials, Board Layout, and Schematics

4.1 Bill of Materials

bq24705-001	bq24704-002	RefDes	Value	Description	Size	Part Number	MFR
0	0	C1, C3, C11, C18	Open	Capacitor, Ceramic, 50V, X7R, 10%	805	Std	Std
5	5	C2, C7, C10, C16, C27	0.1 μ F	Capacitor, Ceramic, 50V, X7R, 10%	805	Std	Std
1	1	C4	1 μ F	Capacitor, Ceramic, 25V, X5R, 10%	603	Std	Std
1	1	C5	100 pF	Capacitor, Ceramic, 50V, COG, 10%	603	Std	Std
2	2	C6, C8	1 μ F	Capacitor, Ceramic, 25V, X5R, 10%	805	Std	Std
6	6	C9, C17, C21, C30, C33, C34	0.1 μ F	Capacitor, Ceramic, 50V, X7R, 10%	603	Std	Std
2	2	C12, C13	10 μ F	Capacitor, Ceramic, 25V, X5R, 10%	1206	Std	Std
4	4	C14, C15, C28, C29	10 μ F	Capacitor, Ceramic, 25V, X5R, 10%	1210	Std	Std
1	1	C19	2.2 μ F	Capacitor, Ceramic, 25V, X5R, 10%	1210	Std	Std
0	0	C20, C26	Open	Capacitor, Ceramic, 25V, X5R, 10%	603	Std	Std
2	2	C22, C23	10 nF	Capacitor, Ceramic, 25V, X5R, 10%	603	Std	Std
0	0	C24, C31	Open	Capacitor, Ceramic, 25V, X5R, 10%	1210	Std	Std
0	0	C25, C32	Open	Capacitor, Ceramic, 25V, X5R, 10%	1206	Std	Std
1	1	D1	BAT54	Diode, Schottky, 200-mA, 30-V	SOT23	BAT54	Vishay-Liteon
5	5	D2, D3, D4, D5, D7	LTST-C190GKT	Diode, LED, Green, 2.1-V, 20-mA, 6-mcd	603	LTST-C190GKT	Lite On
1	1	D6	LTST-C190CKT	Diode, LED, Red, 1.8-V, 20-mA, 20-mcd	603	LTST-C190CKT	Lite On
2	2	J1, J8	D120/2DS	Terminal Block, 2-pin, 15-A, 5.1mm	0.40 \times 0.35 inch	D120/2DS	OST
2	2	J10, J16	ED555/2DS	Terminal Block, 2-pin, 6-A, 3.5mm	0.27 \times 0.25 inch	ED555/2DS	OST
4	4	J4, J11, J12, J14	ED555/3DS	Terminal Block, 3-pin, 6-A, 3.5mm	0.41 \times 0.25 inch	ED555/3DS	OST
4	4	J2, J3, J5, J13	PTC36SAAN	Header, 3-pin, 100mil spacing, (36-pin strip)	0.100 inch \times 3	PTC36SAAN	Sullins
6	6	J6, J7, J9, J15, J17, J18	PTC36SAAN	Header, 2-pin, 100mil spacing, (36-pin strip)	0.100 inch \times 2	PTC36SAAN	Sullins
1	0	L1	4.7 μ H	Inductor, SMT	0.255 \times 0.270 inch	IHLP2525CZ-01	Vishay
0	1	L1	8.2 μ H	Inductor, SMT	0.255 \times 0.270 inch	IHLP2525CZ-01	Vishay
3	3	Q1, Q2, Q3	Si4435DY	MOSFET, P-ch, 30-V, 8.0-A, 20-m Ω	SO8	Si4435DY	Siliconix
2	2	Q4, Q5	FDS6680A	Transistor, MOSFET, NChan, 30V, 12.5A, Rds 9.5 m Ω	SO8	FDS6680A	Fairchild
11	11	Q6, Q7, Q10, Q13, Q15, Q17, Q18, Q19, Q20, Q21, Q22	2N7002DICT	MOSFET, N-ch, 60-V, 115-mA, 1.2- Ω	SOT23	2N7002DICT	Vishay-Liteon
3	3	Q8, Q9, Q11	NDS0605	MOSFET, P-ch, -60 V, 180-mA, 5 Ω	SOT-23	NDS0605	Vishay
3	3	Q12, Q14, Q16	TP0610K	Mosfet, P-Ch, 60V, Rds 6 Ω , Id 185 mA	SOT-23	TP0610K	Vishay-Siliconix

bq24705-001	bq24704-002	RefDes	Value	Description	Size	Part Number	MFR
1	1	R1	430K	Resistor, Chip, 1/16W, 1%	603	Std	Std
1	1	R2	66.5K	Resistor, Chip, 1/16W, 1%	603	Std	Std
8	8	R3, R4, R5, R14, R18, R19, R22, R27	10K	Resistor, Chip, 1/16W, 1%	402	Std	Std
1	1	R6	24.9K	Resistor, Chip, 1/16W, 1%	402	Std	Std
1	1	R7	10K	Resistor, Chip, 1/16W, 1%	603	Std	Std
3	3	R8, R13, R24	100K	Resistor, Chip, 1/10W, 1%	805	Std	Std
1	1	R9	68.0K	Resistor, Chip, 1/10W, 1%	805	Std	Std
2	2	R10, R11	3.9	Resistor, Chip, 0.5W, 5%	1210	Std	Std
1	1	R12	43.0K	Resistor, Chip, 1/10W, 1%	805	Std	Std
3	3	R15, R37, R40	20K	Resistor, Chip, 1/16W, 5%	603	Std	Std
1	0	R16	82.0K	Resistor, Chip, 1/10W, 1%	805	Std	Std
0	1	R16	56.2K	Resistor, Chip, 1/10W, 1%	805	Std	Std
5	5	R17, R20, R21, R23, R26	100K	Resistor, Chip, 1/16W, 1%	402	Std	Std
2	2	R25, R42	0 Ω	Resistor, Chip, 1/16W, 5%	402	Std	Std
6	6	R28, R29, R31, R32, R34, R35	100K	Resistor, Chip, 1/16W, 5%	402	Std	Std
6	6	R30, R33, R36, R38, R39, R41	2.2K	Resistor, Chip, 1/16W, 5%	603	Std	Std
2	2	R43, R44	0.01	Resistor, Chip, 1/2W, 1%	2010	Std	Std
1	1	R45	10k	Resistor, Chip, 1/16W, 1%	603	Std	Std
10	10		929950-00	Shorting jumpers, 2-pin, 100mil spacing,		929950-00	3M/ESD
4	4			6-32 NYL nuts			
4	4		4816	STANDOFF M/F HEX 6-32 NYL 0.500"	sf_thvt_325_rnd	4816	Keystone
4	4	TP1, TP2, TP18, TP19	131-4244-00	Adaptor, 3,5-mm probe clip (or 131-5031-00)	0.200 inch	131-4244-00	Tektronix
10	10	TP4, TP5, TP7, TP8, TP9, TP10, TP13, TP15, TP16, TP17	5002	Test Point, White, Thru Hole Color Keyed	0.100 × 0.100 inch	5002	Keystone
2	2	TP6, TP26	5001	Test Point, Black, Thru Hole Color Keyed	0.100 x 0.100 inch	5001	Keystone
1	0	U1	BQ24705RGE	IC, Host-Controlled Multi-Chemistry Battery Charger	DGN24	BQ24705RGE	TI
0	1	U1	BQ24704RGE	IC, Host-Controlled Multi-Chemistry Battery Charger	DGN24	BQ24704RGE	TI
1	1	—	HPA297	PCB		PCB	Any

Notes: 1. These assemblies are ESD sensitive, ESD precautions shall be observed.
2. These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
3. These assemblies must comply with workmanship standards IPC-A-610 Class 2.
4. Ref designators marked with an asterisk (***) cannot be substituted. All other components can be substituted with equivalent MFG's components.

4.2 Board Layout

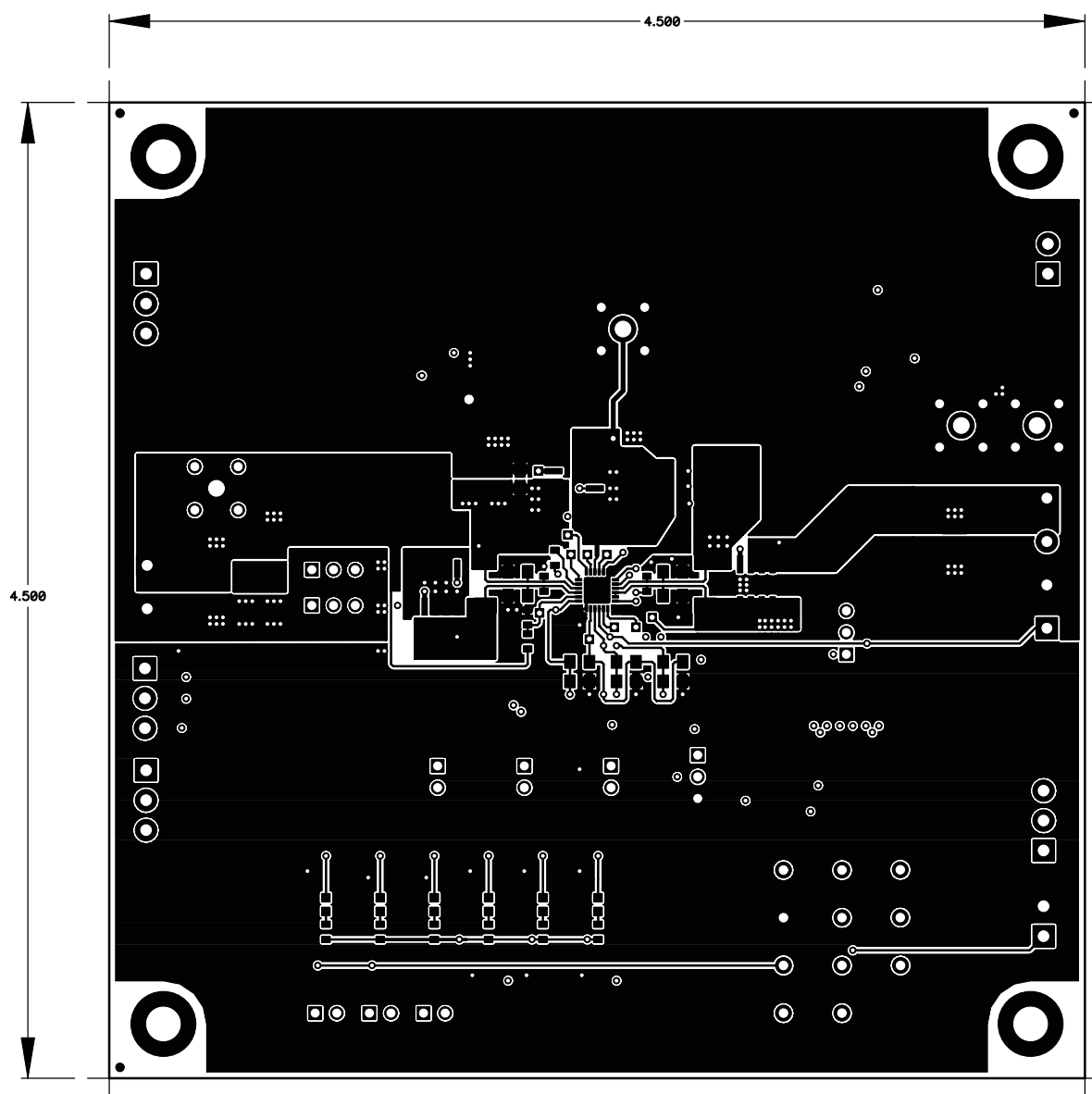


Figure 3. Top Layer

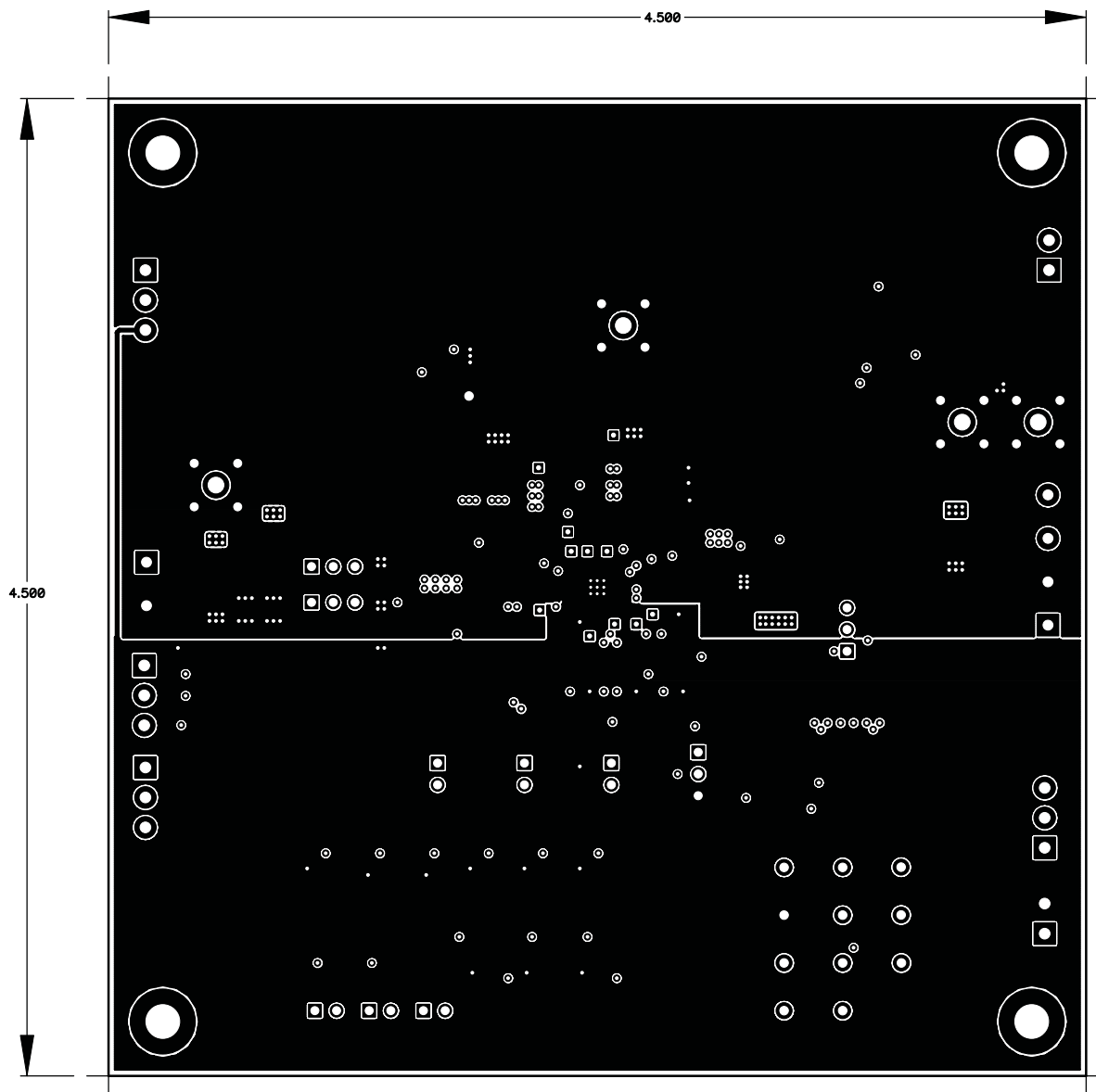


Figure 4. Second Layer

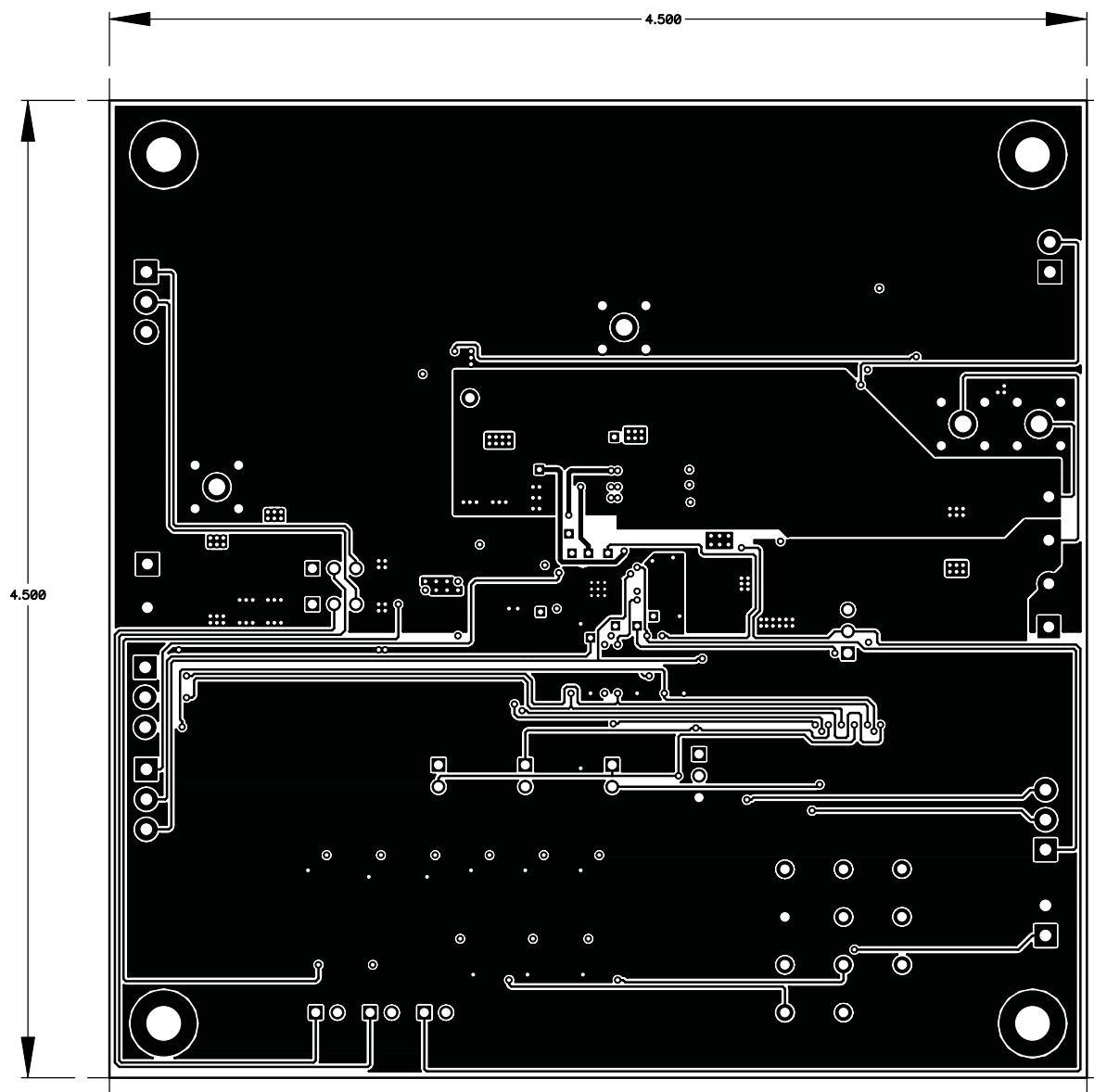


Figure 5. Third Layer

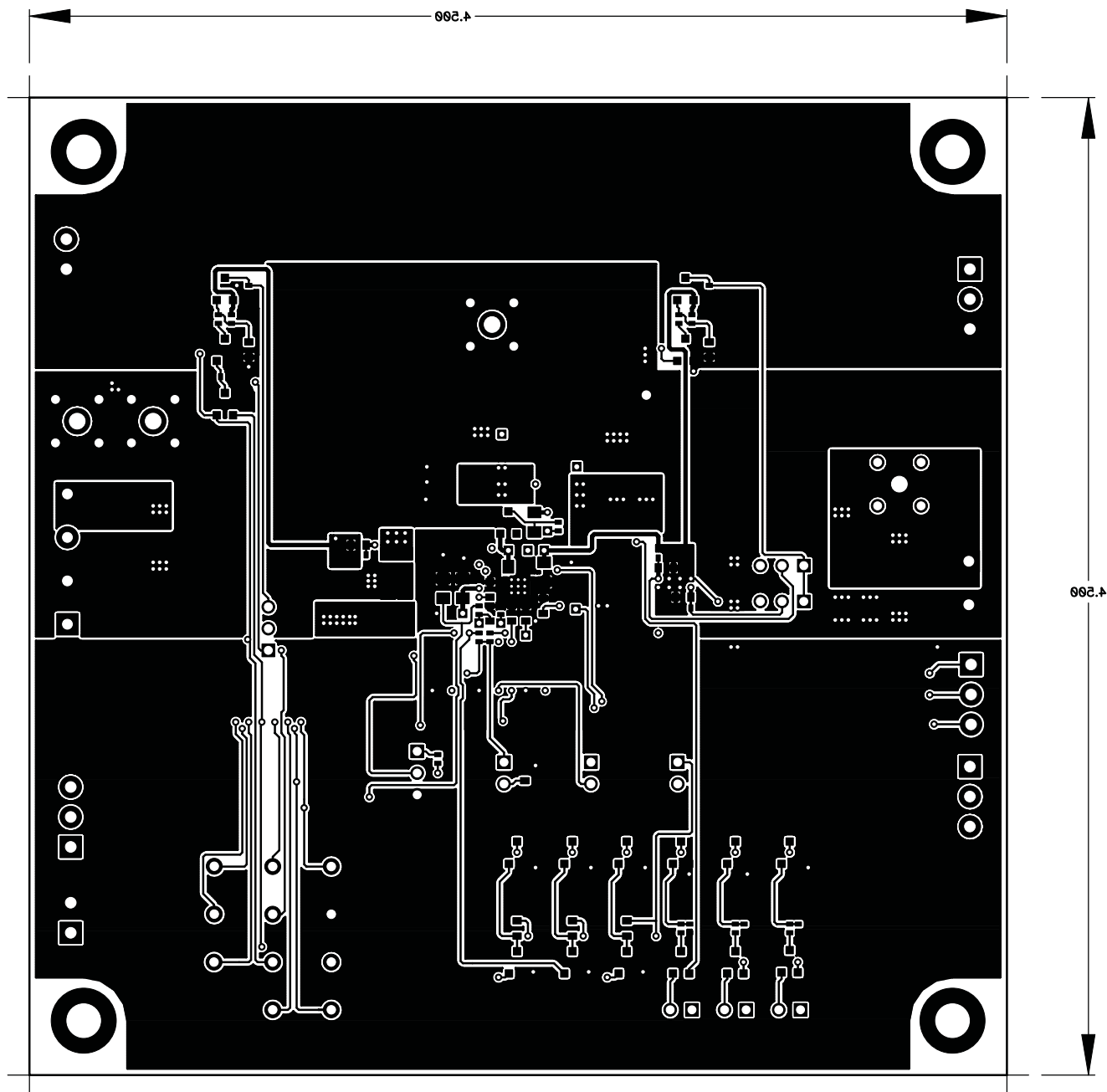


Figure 6. Bottom Layer

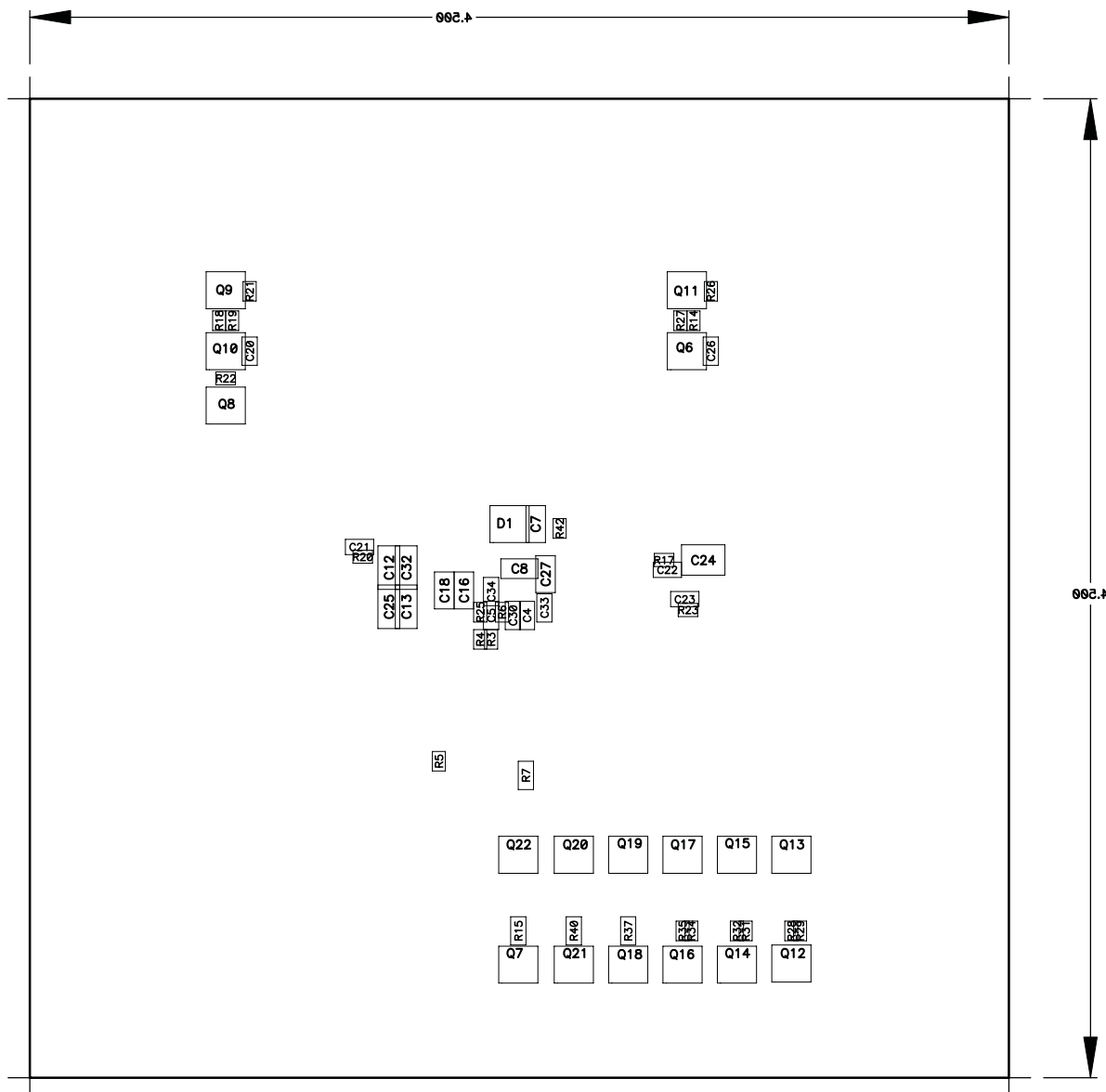


Figure 7. Bottom Assembly

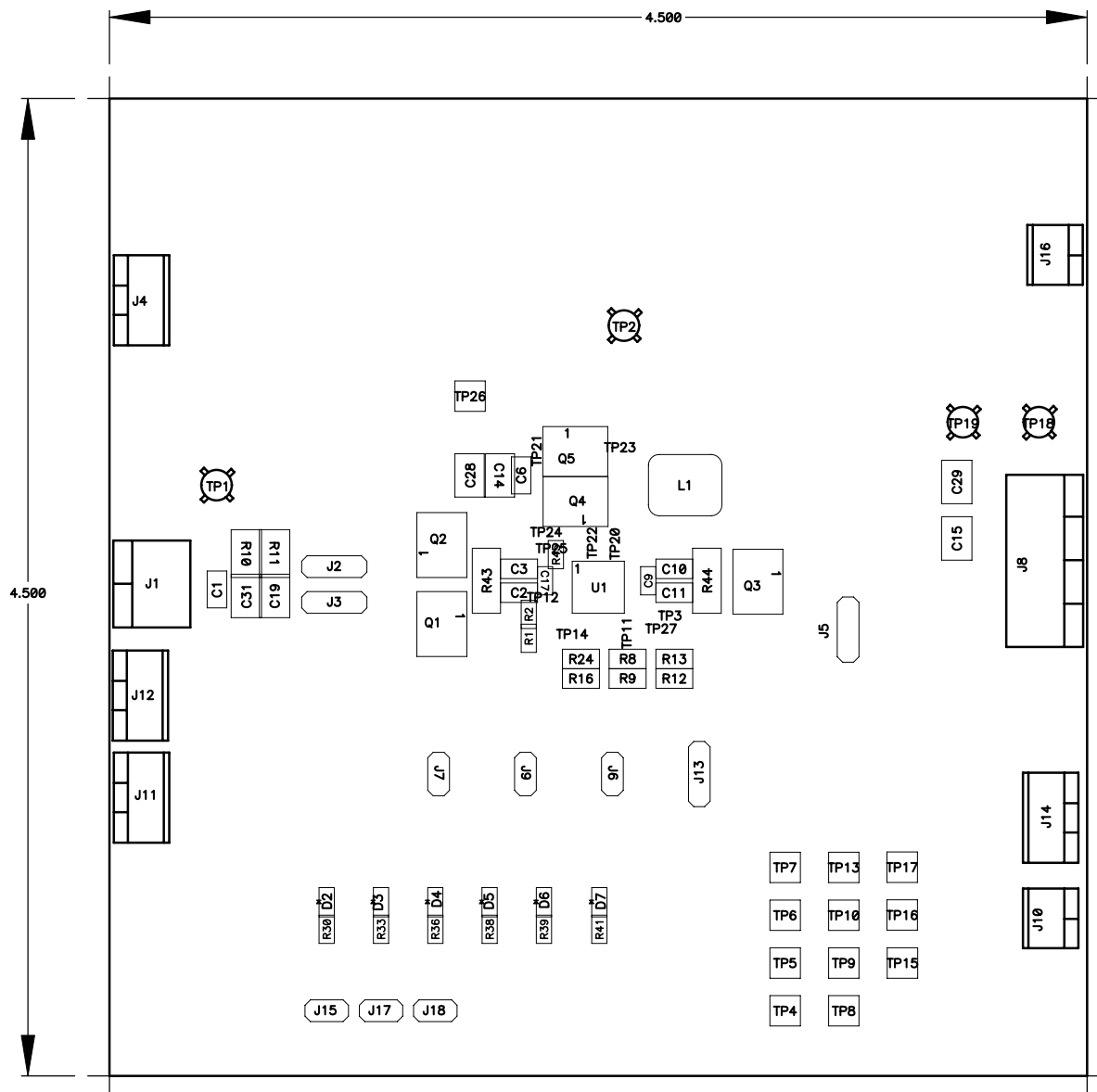


Figure 8. Top Assembly

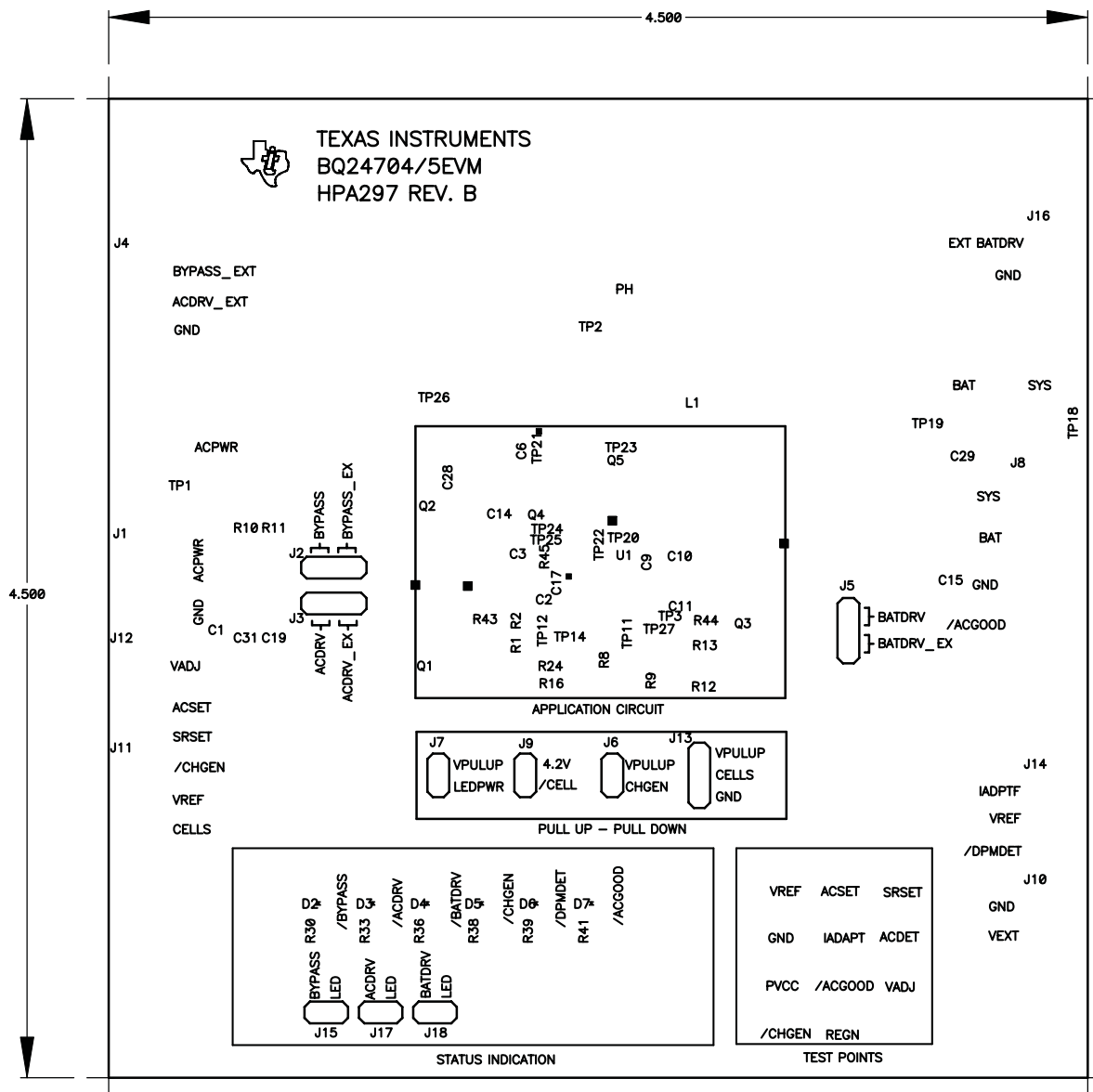
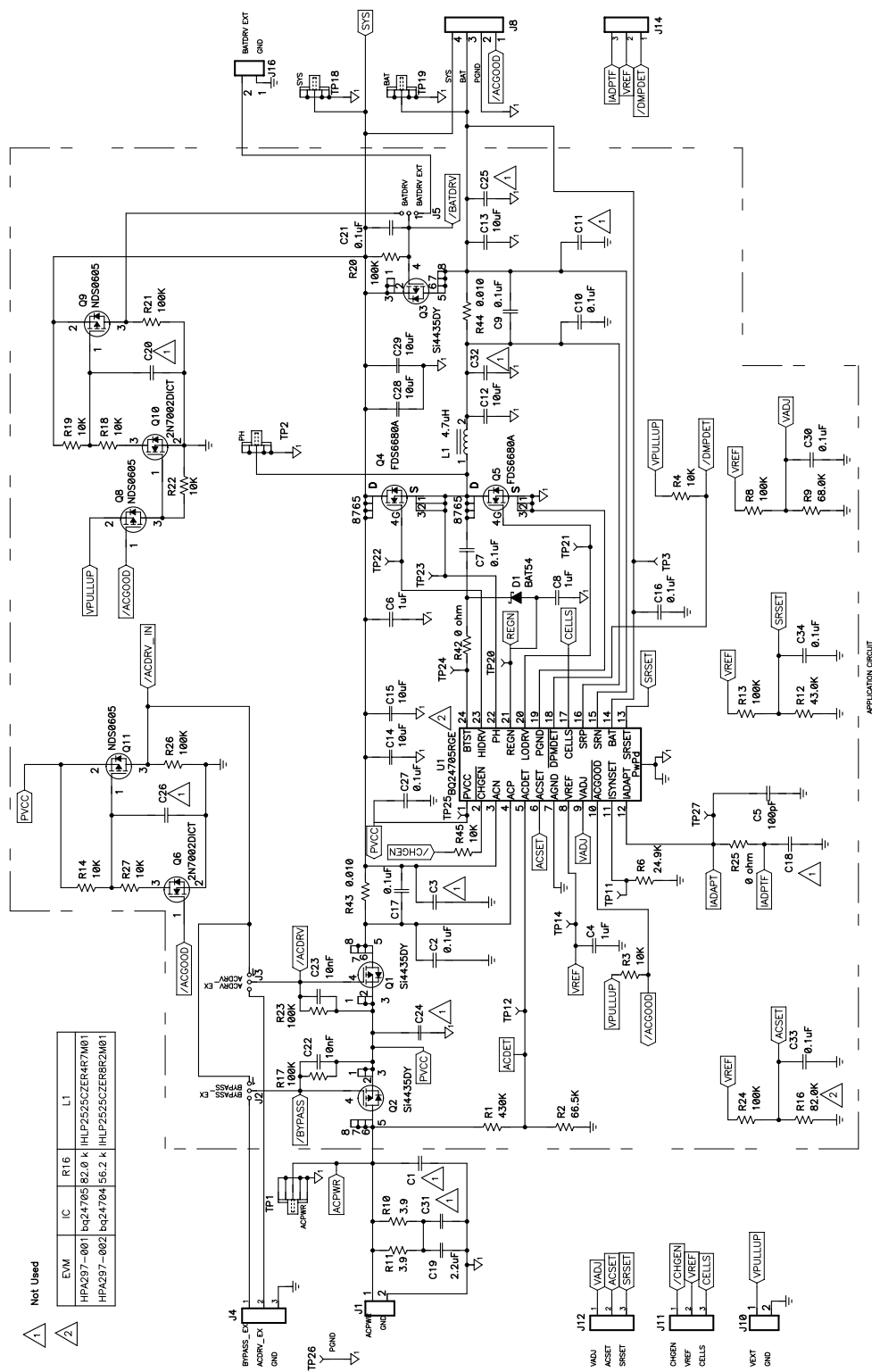


Figure 9. Top Silkscreen

4.3 Schematics

The schematics are affixed to this page.





EVALUATION BOARD/KIT IMPORTANT NOTICE

Texas Instruments (TI) provides the enclosed product(s) under the following conditions:

This evaluation board/kit is intended for use for **ENGINEERING DEVELOPMENT, DEMONSTRATION, OR EVALUATION PURPOSES ONLY** and is not considered by TI to be a finished end-product fit for general consumer use. Persons handling the product(s) must have electronics training and observe good engineering practice standards. As such, the goods being provided are not intended to be complete in terms of required design-, marketing-, and/or manufacturing-related protective considerations, including product safety and environmental measures typically found in end products that incorporate such semiconductor components or circuit boards. This evaluation board/kit does not fall within the scope of the European Union directives regarding electromagnetic compatibility, restricted substances (RoHS), recycling (WEEE), FCC, CE or UL, and therefore may not meet the technical requirements of these directives or other related directives.

Should this evaluation board/kit not meet the specifications indicated in the User's Guide, the board/kit may be returned within 30 days from the date of delivery for a full refund. **THE FOREGOING WARRANTY IS THE EXCLUSIVE WARRANTY MADE BY SELLER TO BUYER AND IS IN LIEU OF ALL OTHER WARRANTIES, EXPRESSED, IMPLIED, OR STATUTORY, INCLUDING ANY WARRANTY OF MERCHANTABILITY OR FITNESS FOR ANY PARTICULAR PURPOSE.**

The user assumes all responsibility and liability for proper and safe handling of the goods. Further, the user indemnifies TI from all claims arising from the handling or use of the goods. Due to the open construction of the product, it is the user's responsibility to take any and all appropriate precautions with regard to electrostatic discharge.

EXCEPT TO THE EXTENT OF THE INDEMNITY SET FORTH ABOVE, NEITHER PARTY SHALL BE LIABLE TO THE OTHER FOR ANY INDIRECT, SPECIAL, INCIDENTAL, OR CONSEQUENTIAL DAMAGES.

TI currently deals with a variety of customers for products, and therefore our arrangement with the user **is not exclusive**.

TI assumes **no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein.**

Please read the User's Guide and, specifically, the Warnings and Restrictions notice in the User's Guide prior to handling the product. This notice contains important safety information about temperatures and voltages. For additional information on TI's environmental and/or safety programs, please contact the TI application engineer or visit www.ti.com/esh.

No license is granted under any patent right or other intellectual property right of TI covering or relating to any machine, process, or combination in which such TI products or services might be or are used.

FCC Warning

This evaluation board/kit is intended for use for **ENGINEERING DEVELOPMENT, DEMONSTRATION, OR EVALUATION PURPOSES ONLY** and is not considered by TI to be a finished end-product fit for general consumer use. It generates, uses, and can radiate radio frequency energy and has not been tested for compliance with the limits of computing devices pursuant to part 15 of FCC rules, which are designed to provide reasonable protection against radio frequency interference. Operation of this equipment in other environments may cause interference with radio communications, in which case the user at his own expense will be required to take whatever measures may be required to correct this interference.

EVM WARNINGS AND RESTRICTIONS

It is important to operate this EVM within the input voltage range of 18 V to 22 V and the output voltage range of 0 V to 18 V.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 60°C. The EVM is designed to operate properly with certain components above 125°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2008-2009, Texas Instruments Incorporated

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products

Amplifiers	amplifier.ti.com
Data Converters	dataconverter.ti.com
DLP® Products	www.dlp.com
DSP	dsp.ti.com
Clocks and Timers	www.ti.com/clocks
Interface	interface.ti.com
Logic	logic.ti.com
Power Mgmt	power.ti.com
Microcontrollers	microcontroller.ti.com
RFID	www.ti-rfid.com
RF/IF and ZigBee® Solutions	www.ti.com/lprf

Applications

Audio	www.ti.com/audio
Automotive	www.ti.com/automotive
Broadband	www.ti.com/broadband
Digital Control	www.ti.com/digitalcontrol
Medical	www.ti.com/medical
Military	www.ti.com/military
Optical Networking	www.ti.com/opticalnetwork
Security	www.ti.com/security
Telephony	www.ti.com/telephony
Video & Imaging	www.ti.com/video
Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2009, Texas Instruments Incorporated

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Texas Instruments:](#)

[BQ24705EVM](#)